1 Characteristics

Table 1.	Absolute ratings	(limiting values	at 25° C	nless otherwise s	pacified)
Table I.	Absolute ratings	(infiniting values	al 25 C, u	mess otherwise s	specified)

Symbol	F		Value	Unit		
V _{RRM}	Repetitive peak reverse voltage	lepetitive peak reverse voltage				
I _{F(RMS)}	RMS forward current				А	
		TO-220AB / D ² PAK	Per diode $T_c = 150^{\circ} C$	8		
.	Average ferward surrent $\delta = 0.5$	TU-220AB / D PAK	Per device $T_c = 145^{\circ} C$	16	А	
IF(AV)	Average forward current, $\delta = 0.5$	TO-220FPAB	Per diode $T_c = 125^{\circ} C$	8	A	
		10-220FPAD	Per device $T_c = 90^\circ C$	16		
I _{FSM}	Surge non repetitive forward current	current t _p = 10 ms Sinusoidal			А	
T _{stg}	Storage temperature range	-65 to +175	°C			
Тj	Maximum operating junction tempera	ature range		-40 to +175	°C	

Table 2.Thermal parameters

Symbol		Parameter				
		TO-220AC / D ² PAK	Per diode	2		
В	Junction to case	TO-220AC/D FAR	Per device	1.15	°C/W	
R _{th(j-c)} Junctio	Junction to case	TO-220FPAB	Per diode	4.6	0/10	
		10-2201	TO-220FFAD	per device	3.8	
P	Coupling	TO-220AC / D ² PAK	Per device	0.3	°C/W	
R _{th(c)}	Coupling	TO-220FPAB	per device	3	0,00	

When the diodes are used simultaneously:

 $\Delta T_{j(diode \ 1)} = P_{(diode \ 1)} \ x \ R_{th(j-c)(Per \ diode)} + P_{(diode \ 2)} \ x \ R_{th(c)}$

Symbol	Parameter	Test conditions		Min	Тур	Max	Unit
I _B ⁽¹⁾	Povorso lookago gurront	T _j = 25° C	V V			10	
IR ⁽¹⁾ Reverse leakage current	T _j = 125° C	$V_{R} = V_{RRM}$		10	100	μA	
		$T_j = 25^\circ C$				1.5	
VF ⁽²⁾ Forward voltage drop	$T_j = 100^\circ C$	I _F = 8 A		1.05	1.3		
	Forward voltage drop	$T_j = 150^\circ C$			0.9	1.1	v
	Forward voltage drop	$T_j = 25^\circ C$				1.75	v
	-	$T_j = 100^\circ C$	I _F = 16 A		1.25	1.55	
		$T_j = 150^\circ C$			1.12	1.37	

 Table 3.
 Static electrical characteristics

1. Pulse test: $t_p = 5 \text{ ms}, \delta < 2 \%$

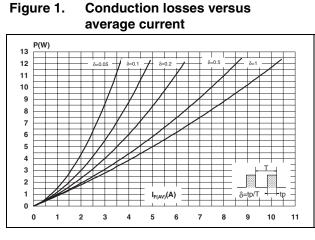
2. Pulse test: t_p = 380 µs, δ < 2 %

To evaluate the conduction losses use the following equation: P = 0.83 x $I_{F(AV)}$ + 0.034 x ${I_F}^2_{(RMS)}$

Table 4.Dynamic characteristics

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
+	Reverse recovery time	$\label{eq:lf} \begin{array}{l} I_F = 1 \mbox{ A, } dI_F/dt = -50 \mbox{ A/}\mu s, \\ V_R = 30 \mbox{ V, } T_j = 25^{\circ} \mbox{ C} \end{array}$		35	50	ns
t _{rr}	neverse recovery time	$I_F = 1 \text{ A}, dI_F/dt = -100 \text{ A}/\mu\text{s}, V_R = 30 \text{ V}, T_j = 25^{\circ} \text{ C}$		25	35	115
I _{RM}	Reverse recovery current	$I_F = 8 \text{ A}, \text{ d}I_F/\text{d}t = -200 \text{ A}/\mu\text{s},$ $V_R = 320 \text{ V}, \text{ T}_j = 125^\circ \text{ C}$		5.5	8	А
S	Softness factor	I_F = 8 A, dI_F/dt = -200 A/µs, V_R = 320 V, T_j = 125° C		0.4		
t _{fr}	Forward recovery time	$I_F = 8 \text{ A}, \text{ dI}_F/\text{dt} = 100 \text{ A}/\mu\text{s}$ $V_{FR} = 1.1 \text{ x } V_{Fmax}, \text{ T}_j = 25^{\circ} \text{ C}$			150	ns
V _{FP}	Forward recovery voltage	$I_F = 8 \text{ A}, \text{ d}I_F/\text{d}t = 100 \text{ A}/\mu\text{s}$ $T_j = 25^{\circ} \text{ C}$		2.9		V





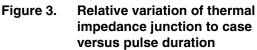


Figure 2. Forward voltage drop versus forward current

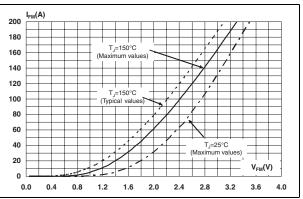


Figure 4. Relative variation of thermal impedance junction to case versus pulse duration TO-220FPAB

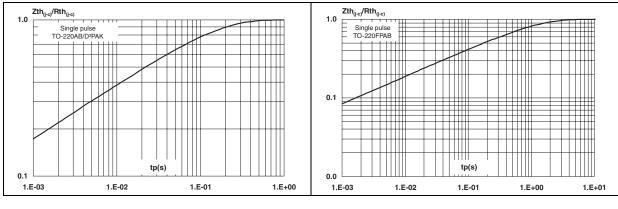


Figure 5. Peak reverse recovery current versus dl_F/dt (typical values)

Figure 6. Reverse r

Reverse recovery time versus dl_F/dt (typical values)

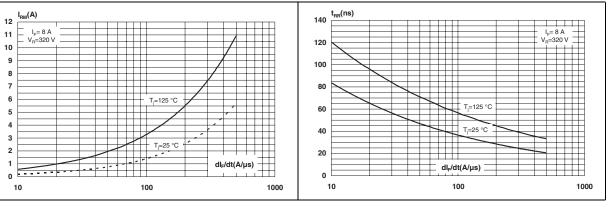
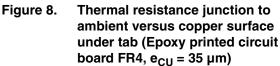




Figure 7. Reverse recovery charges versus dl_F/dt (typical values)



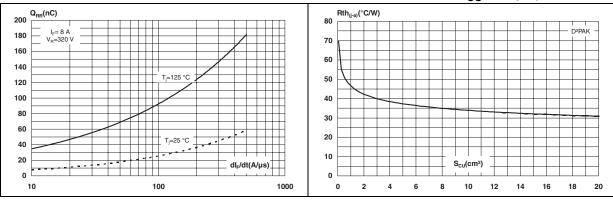


Figure 9. Relative variations of dynamic parameters versus junction temperature

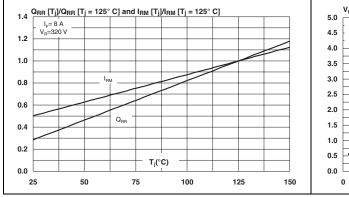


Figure 10. Transient peak forward voltage versus dl_F/dt (typical values)

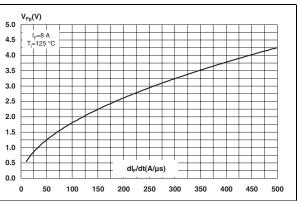
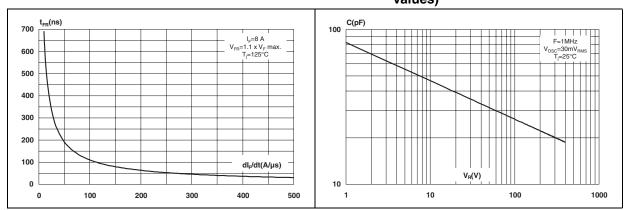


Figure 11. Forward recovery time versus dl_F/dt Figure 12. (typical values)

Junction capacitance versus reverse voltage applied (typical values)



5

2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.8 Nm (TO-220FPAB) / 0.55 Nm (TO-220AB)
- Maximum torque value: 1.0 Nm (TO-220FPAB) / 0.70 Nm (TO-220AB)

Table 5. D²PAK dimensions

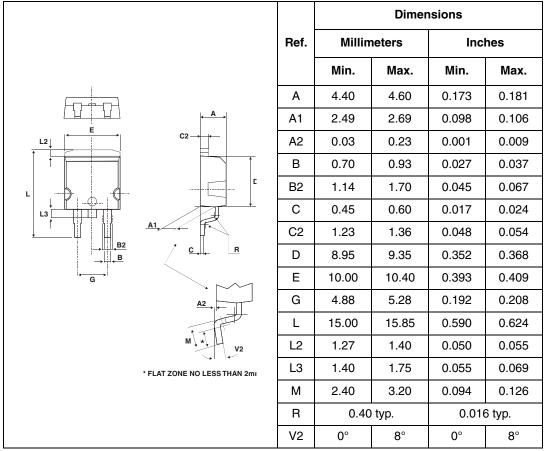
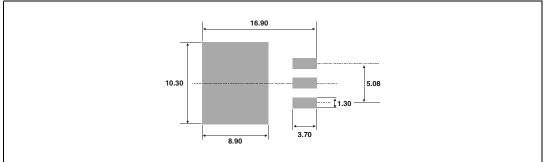


Figure 13. D²PAK footprint (dimensions in mm)



					Dimer	nsions			
		Ref.	Mi	illimete	rs	Inches			
			Min.	Тур.	Max.	Min.	Тур.	Max.	
		А	15.20		15.90	0.598		0.625	
		a1		3.75			0.147		
ØI b2	C I	a2	13.00		14.00	0.511		0.551	
		В	10.00		10.40	0.393		0.409	
	F	b1	0.61		0.88	0.024		0.034	
A		b2	1.23		1.32	0.048		0.051	
14 I3		С	4.40		4.60	0.173		0.181	
	c2	c1	0.49		0.70	0.019		0.027	
+ 12		c2	2.40		2.72	0.094		0.107	
		е	2.40		2.70	0.094		0.106	
	M	F	6.20		6.60	0.244		0.259	
		ØI	3.75		3.85	0.147		0.151	
		14	15.80	16.40	16.80	0.622	0.646	0.661	
		L	2.65		2.95	0.104		0.116	
		12	1.14		1.70	0.044		0.066	
		13	1.14		1.70	0.044		0.066	
		М		2.60			0.102		

Table 6. TO-220AB dimensions



Table 7. 10-220FPAB	uiiieiisioiis						
			Dimensions				
		Ref.	Millimeters		Inches		
			Min.	Max.	Min.	Max.	
		А	4.4	4.6	0.173	0.181	
	Α.	В	2.5	2.7	0.098	0.106	
! ← H →	B	D	2.5	2.75	0.098	0.108	
		E	0.45	0.70	0.018	0.027	
		F	0.75	1	0.030	0.039	
L6		F1	1.15	1.70	0.045	0.067	
L2		F2	1.15	1.70	0.045	0.067	
L3		G	4.95	5.20	0.195	0.205	
	- /	G1	2.4	2.7	0.094	0.106	
→		Н	10	10.4	0.393	0.409	
L4 <u>→ F2</u>		L2	16	Тур.	0.63	Тур.	
↓ ↓ ∅ ₩ ↓ ↓↓↓	<u>E</u>	L3	28.6	30.6	1.126	1.205	
G1 ↔		L4	9.8	10.6	0.386	0.417	
G		L5	2.9	3.6	0.114	0.142	
		L6	15.9	16.4	0.626	0.646	
		L7	9.00	9.30	0.354	0.366	
		Dia.	3.00	3.20	0.118	0.126	

Table 7.TO-220FPAB dimensions

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

3 Ordering information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
STTH16R04CT	STTH16R04CT	TO-220AB	1.92 g	50	Tube
STTH16R04CG	STTH16R04CG	D ² PAK	1.48 g	50	Tube
STTH16R04CG-TR	STTH16R04CG	D ² PAK	1.48 g	1000	Tape and reel
STTH16R04CFP	STTH16R04CFP	TO-220FPAB	1.69 g	50	Tube

4 Revision history

Date	Revision	Description of Changes
31-Mar-2007	1	First issue



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